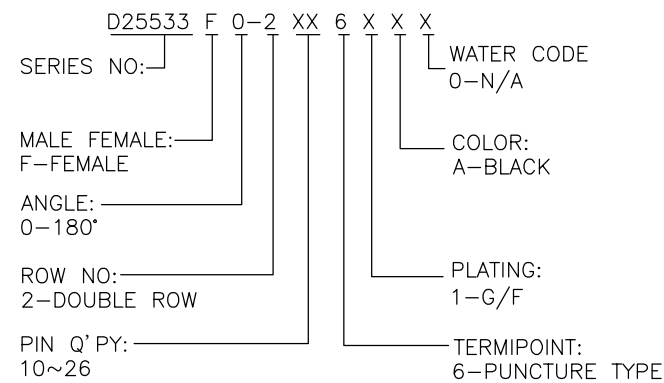


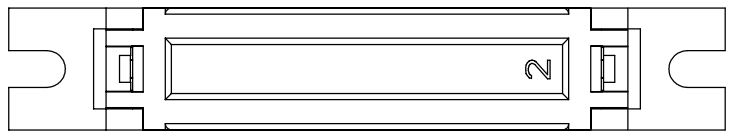
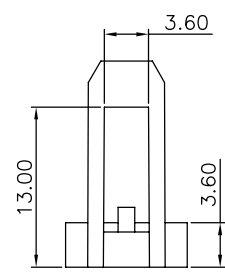
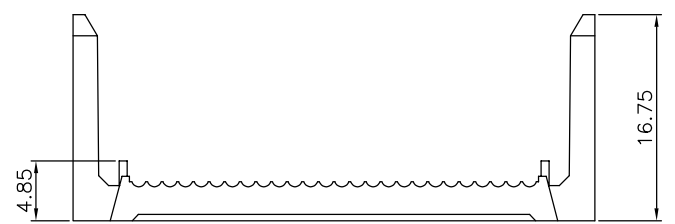
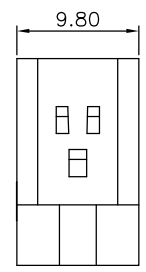
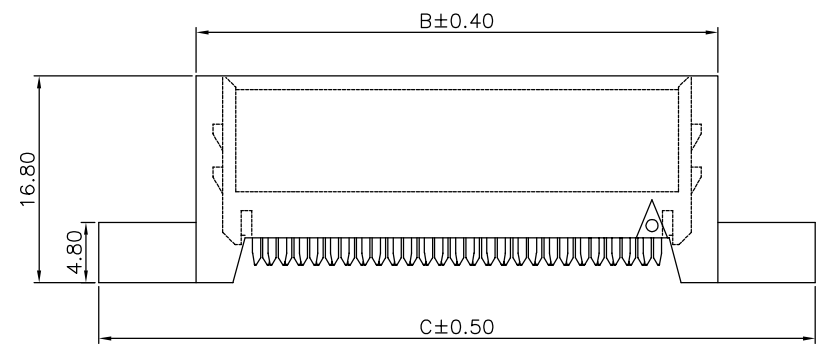
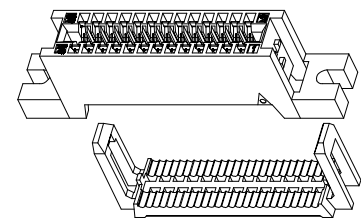
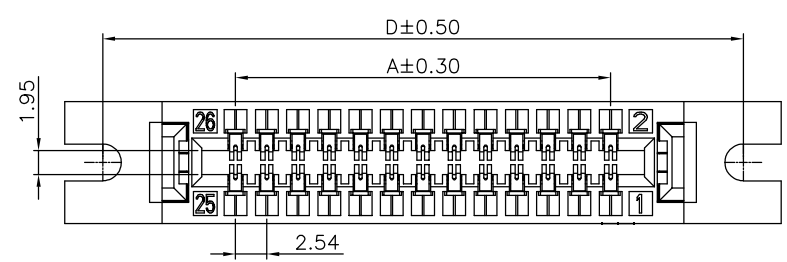
The product using material and processing must conform to the "WI-PZ-001" HSF technical standard control requirements



NOTE:  
 1.MATERIAL SPECIFICATION:  
 1-1.HOUSING: PBT,94V-0  
 1-2.CONTACTS: BRASS  
 2.PLATING SPECIFICATION:  
 2-1.CONTACTS:  
 NI/GOLD FLASH PLATED OVER ALL.  
 3.ELECTRICAL PERFORMANCE:  
 3-1.CURRENT RATING: 1A AC/DC  
 3-2.CONTACT RESISTANCE: 20 mΩ MAX  
 3-3.INSULATION RESISTANCE: 1000MΩ Min  
 3-4.DIELECTRIC WITHSTANDING : 500V  
 4.ENVIRONMENTAL PERFORMANCE:  
 4-1.OPERATING TEMPERATURE: -25°C~+85°C.  
 5.PACKAGE SPEC: TRAY  
 6.P/N:



Circuit	Dimensions(mm)			
	A	B	C	D
10	10.16	22.10	37.92	31.72
14	15.24	27.18	43.00	36.80
16	17.78	29.72	45.54	39.34
20	22.86	34.80	50.62	44.42
24	27.94	39.88	55.70	49.50
26	30.48	42.42	58.24	52.04



REV.	REVISION RECORD	DATE	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:
AO	NEW RELEASE	22.03.19	LINEAR	ANGLES	1:1	Wang_jr	22.03.19	D25533F0-2XX6XXX	ENDE05
			0.0±0.35	X'REF±6'	APPROVED	XueZe_Ma	22.03.19	TITLE:	
			0.00±0.25	X'±3'	CHECK	LanXuan_Hou	22.03.19	Pitch 2.54 IDC (金手指)母座	
			UNIT:mm	X'X' ±2'	DRAWN				
			SIZE: A4	0.000±0.10					

WanLian Technology Co., Ltd  
 REV: A0 SHEET: 1/1